Detroit Automotive Center & EMC Test Lab

EMC Insights and Solutions

April 2022



rev 20180504

Presenter Intro: Barry Steltz

- Head of MPS EMC Lab in Detroit
- 20+ Years Experience in Automotive EMC Test and Design in Michigan
- 10+ Years Experience in Military & Commercial EMC Test & Design in Pennsylvania
- Designed, Built and Managed 4 Automotive EMC Labs
- Led the ISO 17025 Accreditation of 2 EMC Labs and Currently Working on the Third
- Additional Experience: Design and Quality Assurance Engineer
- Related Experience: 10 years Ford, 10 Years Hitachi, 3 years at MPS
- iNARTE Certified EMC Engineer
- BSEE and MBA Pennsylvania State University





Detroit Automotive Center

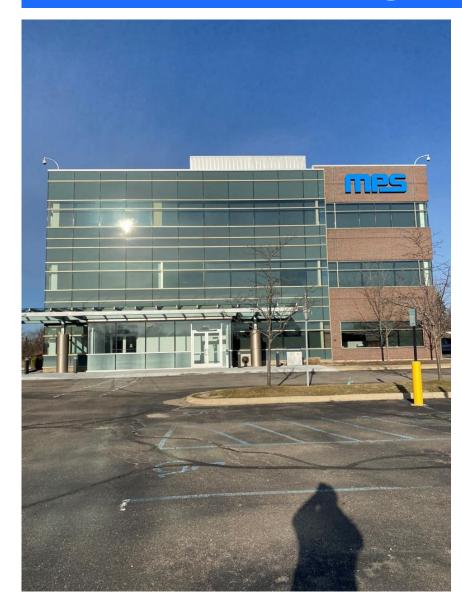
EMC Testing Facilities

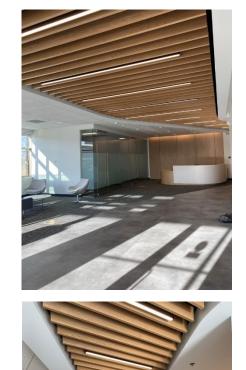
Practical and Early Testing Showcases

Open Q&A



MPS – Detroit Michigan

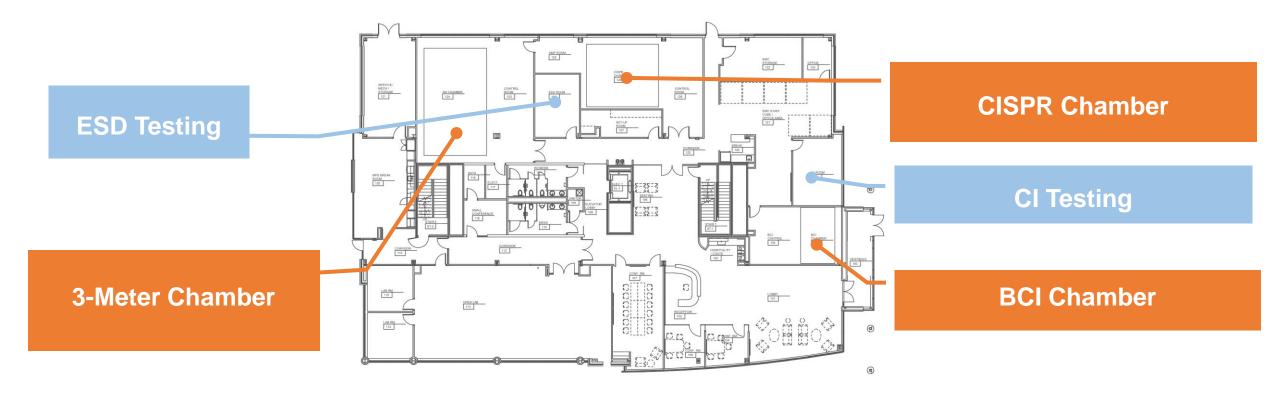






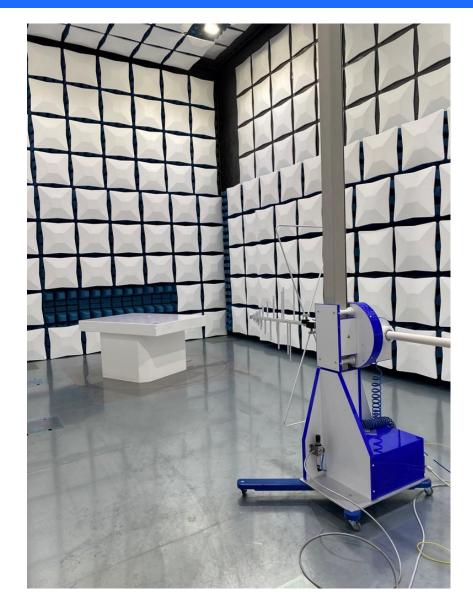


MPS Livonia





3 Meter Chamber

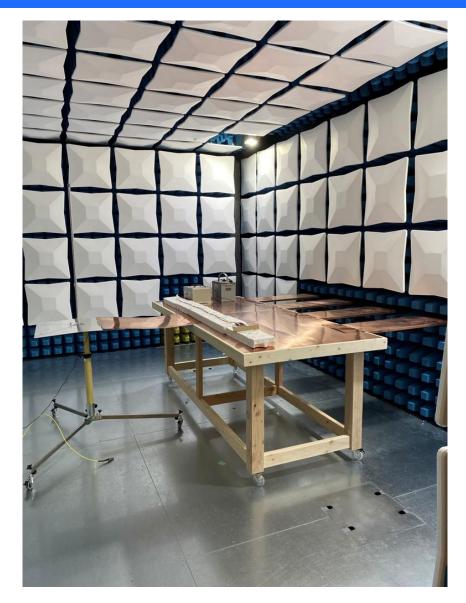


Automotive & Commercial

- ✓ Radiated Emissions (RE)
- \checkmark Conducted Emissions (CE)
- Commercial
- ✓ Radiated Immunity (RI)
- **Specifications**
- ✓ CISPR25, CISPR32, ISO11452-9, IEC61000-4-3, FCC Part 15



CISPR Chamber



Automotive

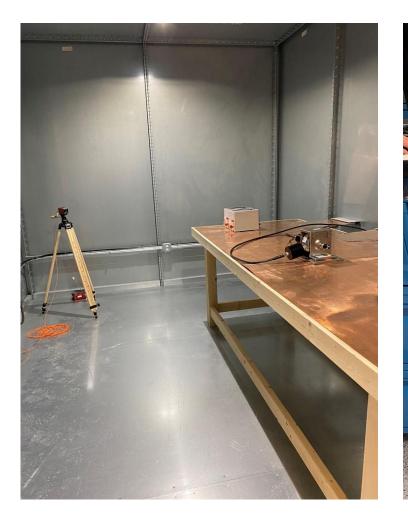
- ✓ Radiated Emissions (RE)
- ✓ Conducted Emissions (CE)
- ✓ Radiated Immunity (RI)

Specifications

✓ CISPR25, ISO11452-9, ISO11452-2



BCI Chamber & Test Rack



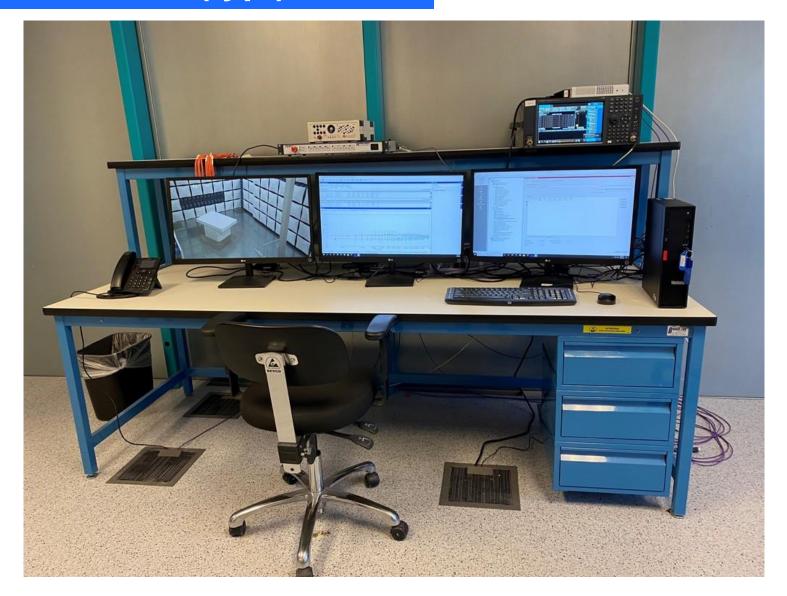


Automotive & Commercial

✓ Bulk Current Injection (BCI)
✓ Magnetic Immunity
Specifications
✓ ISO11452-8, ISO11452-4, IEC61000-4-6

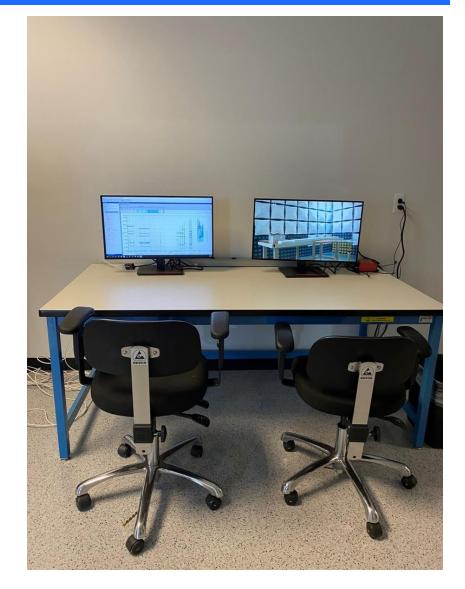


Chamber Test Station (typ.)





Chamber Customer Monitoring Station (typ.)





CI Room





Automotive & Commercial Conducted Immunity(CI) Specifications ✓ ISO7637-2/3 ✓ ISO 16750-4 ✓ IEC 61000-4-4/5/11 VDI ✓ ANSI/IEEE C62.41



ESD Room



Automotive & Commercial Electro Static Discharge(ESD) Specifications ✓ ISO10605 ✓ IEC61000-4-2



RI Magnetic





RI Near Field





Practical and Early Testing Showcases



Why is EMC important? – Functional point of view

Products need to work in a rough enviroment without emitting to much noise which can effect other products



Why is EMC important? – Economic point of view

EMC results could effect the success of a product and the whole company.

To be successful in the long term, you have to be able to sell your products.



But you can only sell your products if you fulfil the EMC requirements.



Passing EMC is essential, if you would like to fullfil company goals and be successful.

A robust EMC development process shows the best possible compromise between...





How Does EMC Become a Success Factor for Your Design Project?

Understanding the Roots/Background of EMC and the defined Requirements

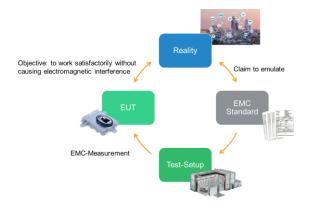
- Obtain the requirements for the product
- Define supplier requirements
- Define a test plan for the product and subassemblies

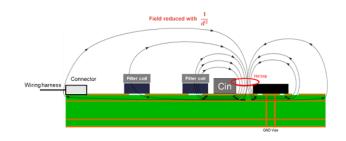
Consider EMC from the beginning of the Project

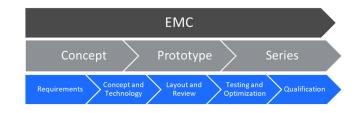
- Combine the mechanical and electrical concepts to determine the best overall concept
- Conduct pre-tests by evaluating components to find the appropriate functional, thermal, and EMC viewpoints

Clearly-structured EMCdevelopment Process

- Conduct a hardware review and identify critical paths
- Leave room for additional filtering and modifications at the first layouts for investigations during a pre-test
- Planning EMC tests during development (early state) and testing loops







Conduct pre-tests by evaluating components to find the appropriate functional, thermal, and EMC viewpoints

- Discuss with your suppliers layout requirements, mandory components, options and different operational modes
 - $\circ\,$ Determine -How to set and choose the correct switching frequency
 - Possible other options which include(BST-Resistor, Spread Spectrum), Shielding,
 - Input filter (1-Stage / 2 Stage, Input-Caps...)
- Start testing with Evaluation-Boards and first prototypes to get a feeling and general understanding of the product/part.



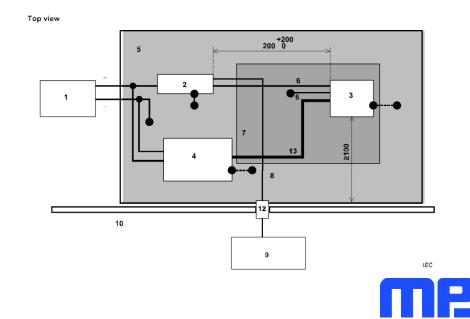
Planning EMC tests during development (early state) and testing loops

- Leave room for additional filtering and modifications at the first layouts for investigations during a pre-test
- Get in touch with the Lab and define a test plan for the test-session
 - Talk about needed equipment and interfaces
 - $_{\odot}$ Which power connectors are needed?
 - o What should the wiring harness look like?
- Be realistic and plan testing loops to improve the product during the different testing states



Planning EMC tests during development (early state) and testing loops

- Take (all) documents and spare parts with you to the Lab
 - Datasheets of the components used + Schematic + Layout
 - Reference Board from old measurements or previous internal measurements
 - Take spare PCBs and parts with you, as well as alternative components (different caps and inductors...)
- Prepare the test setup
 - Test Hardware and Software
 - $_{\odot}\,$ Prepare all cables/harness and periphery
 - $\,\circ\,$ Make a list of all parts you need



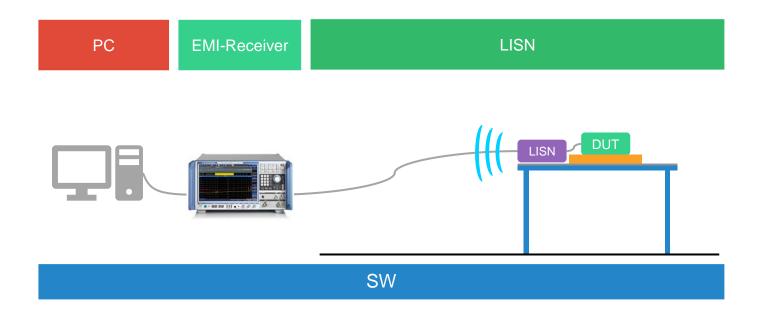
Overview – Test methods (Automotive)

	DC	9 kHz	100 kHz	150 kHz	30 MHz	80 MHz	108 MHz	200 MHz	400 MHz	1 GHz	3 GHz	6 GHz
Emission - Automotive												
Conducted Emission (CE) – CISPR25 – Voltage method												
Conducted Emission (CE) – CISPR25 – Current probe method												
Radiated Emission (RE) – CISPR25 – ALSE method												
Radiated Emission (RE) – CISPR25 – Stripline method												
Immunity - Automotive											·	
Conducted Immunity (CI) – ISO 11452-4 – BCI												
Radiated Immunity (RI) – ISO 11452-2 – Antenna method												
Radiated Emission (RI) – ISO 11452-9 – HTX												
Radiated Emission (RI) – ISO 11452-8 – Magnetic Field												



Conducted Emission

You should be able to put the DUT at a functional status like in the real application with the worst case operation for Emission Testing.

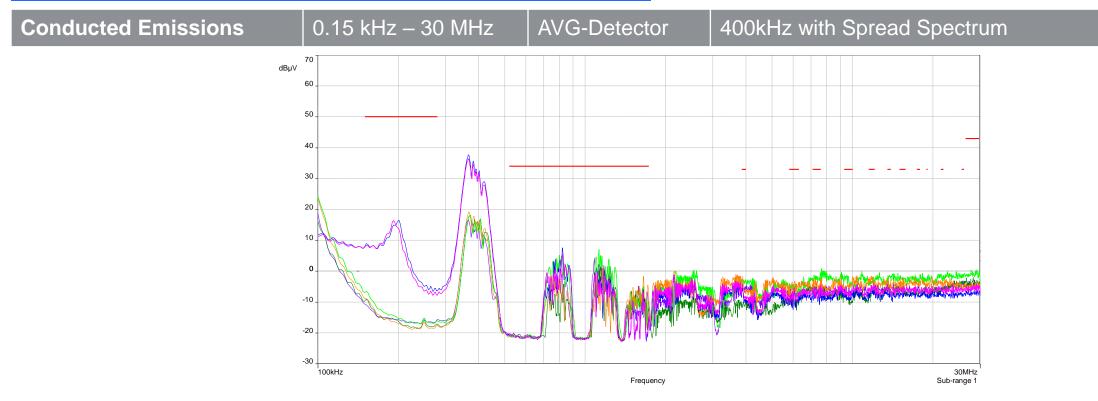


Conducted Emission measurements gives you a very good overview about your application in a short time.

- The measurement is quite fast
- The effort for the test setup is quite small.
- You can do the testing with a pre-compliance setup very good.



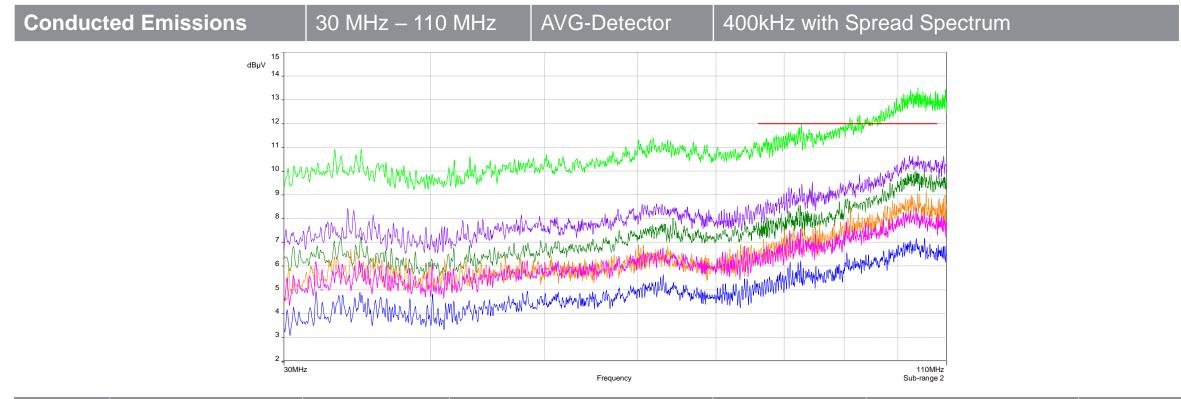
Conducted Emissions



	Component	Component	Layout	Input-Filter	Layout	Result
Initial Setup						
Mod 1	Main-Coil turned by 180°					
Mod 2	Main-Coil turned by 180°	Main-Coil changed				
Mod 3	Main-Coil turned by 180°	Main-Coil changed	Reduced SW-Loop and Vout-Traces			
Mod 4	Main-Coil turned by 180°	Main-Coil changed	Reduced SW-Loop and Vout-Traces	modifyed Input-Filter		+18 dB
Mod 5	Main-Coil turned by 180°	Main-Coil changed	Reduced SW-Loop and Vout-Traces	modifyed Input-Filter	modifyed positions of Couts	0 dB



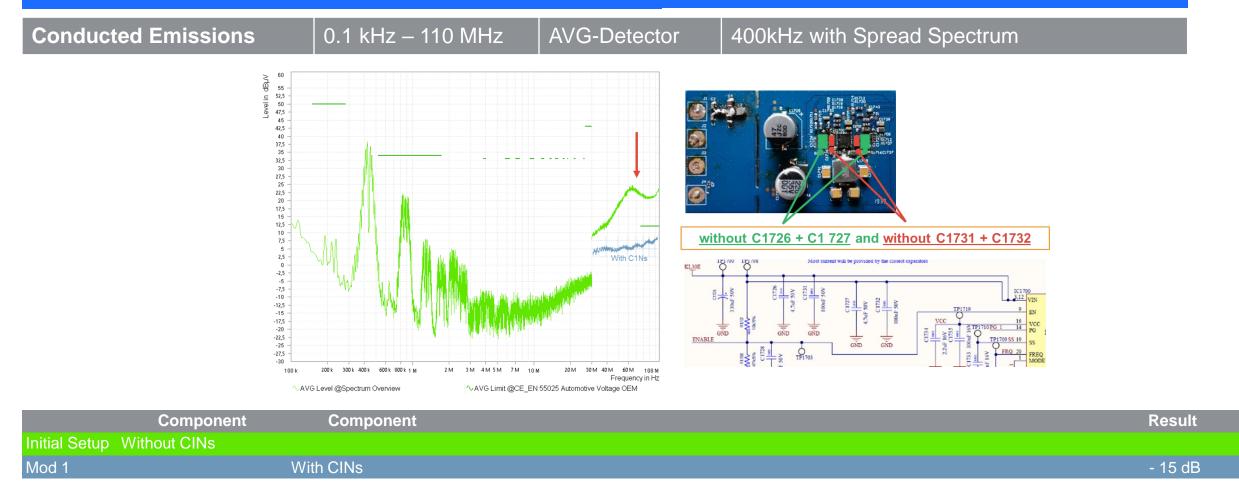
Conducted Emissions



	Component	Component	Layout	Input-Filter	Layout	Result
Initial Setup						
Mod 1	Main-Coil turned by 180°					- 3 dB
Mod 2	Main-Coil turned by 180°	Main-Coil changed				- 0.5 dB
Mod 3	Main-Coil turned by 180°	Main-Coil changed	Reduced SW-Loop and Vout-Traces			-0.8 dB
Mod 4	Main-Coil turned by 180°	Main-Coil changed	Reduced SW-Loop and Vout-Traces	modifyed Input-Filter		-0.8 dB
Mod 5	Main-Coil turned by 180°	Main-Coil changed	Reduced SW-Loop and Vout-Traces	modifyed Input-Filter	modifyed positions of Couts	1.4 dB

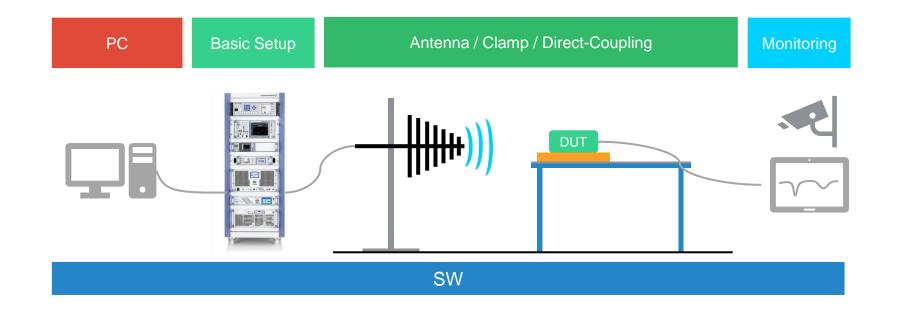


Conducted Emissions





You should be able to put the DUT at a functional status like in the real application and to monitor all relevant signals to understand the reaction on the disturbance if something happen.



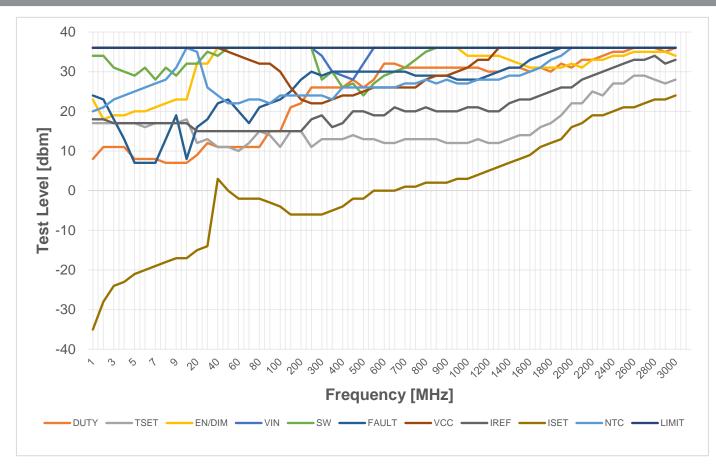
You want to test performance degradation in the presence of an electromagnetic disturbance. During the disturbance you have to monitor the DUT

- Optical via camera / Analog-Signals (Input-Voltage, Input-Current, Output-Voltage...) / Digital-Ports / Communication-Interfaces (LIN, CAN, Flexray...)



Immunity Behavior

Robustness against Disturbances



Some pins of a IC are sensitive per definition. Sensitive Pins needs to be routed carefully on the PCB. Traces could be act as an antenna.



Questions

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